

DETECTOR DEVELOPMENT AT APS

"Make no little plans; they have no magic to stir men's blood and probably themselves will not be realized." - Daniel Burnham



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DETECTORS AT THE APS

Resources aligned to prioritize

- -Detector Pool: Introduce new, cutting-edge commercial detectors
- -Detector R&D: Projects compelling to APS-U science.
- Detector R&D plan
 - Transition Edge Sensors (TESs) for emission spectroscopy (E > 1 keV)
 - Enable new science APS-U: ISN, Ptycho, Polar (APS, NIST, SLAC)
 - VIPIC for XPCS (Vertically Integrated Photon Imaging Chip)
 - Enhanced coherence of APS-U: WA- & SA-XPCS, CHEX, CSSI (NSLS-II, APS, Fermilab)
 - Germanium for high-energy applications (NSLS-II, APS)
 - APS is a high-energy light source \rightarrow efficient sensors
 - High-Energy, High Dynamic Range Area Detectors
 - High-energy MM-PAD v2.0 (Cornell, APS)





X-ray Transition Edge Sensors (TESs)

E/∆E > 1,000 can be achieved in high-efficiency energy dispersive detectors Energy spectra measured over entire energy range simultaneously using transition-edge sensors (TES) Expands application of X-ray spectroscopy

e.g., time-resolved & nanoscale imaging of dilute, radiation-sensitive samples Challenge: tension between sensor resolution, speed, collecting area Improved theoretical understanding of superconducting transition guiding sensor design



(a) Comparison of the Mn K α spectrum measured by the three TES devices, normalized at the peak maxima. A low-energy (LE) tail is observed only in the Au/evaporated-Bi absorber devices (b) Scanning electron micrograph of the Au/evaporated-Bi absorber. Inset: X-ray diffraction pattern of electroplated-Bi. (c) Scanning electron micrograph of the Au/electroplated-Bi absorber cross-sections. Inset: X-ray diffraction pattern of electroplated-Bi.

D. Yan, et al, Appl. Phys. Lett. 111, 192602 (2017), doi: 10.1063/1.5001198

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R&D Accomplishments

- Microwave SQUID readout with high bandwidth (2 MHz/pixel); Room-temperature electronics built on LCLS ATCA platform
- Soft X-ray sensors achieved 1.0 eV and 80 μs response time
- Hard X-ray sensors achieved with Gaussian response

Science-grade Spectrometers

- APS XAFS/XES funded
- LCLS-II SXR funded



High-energy X-ray Germanium Detectors

Hard X-ray energy-resolving applications

High-quality Ge sensors efficient at high energies (E > 20 keV) for spectroscopic applications Improve efficiency of high-energy applications

Parallel collection of spatially-resolved, energy-dispersive diffraction

Suppression of unwanted fluorescence background in powder diffraction experiments

Lack of high-quality high-energy sensors

Combines BNL's low-noise readout integrated circuits with 1D germanium sensors arrays



A 384-strip germanium sensor is wire bonded to twelve low noise ASICs. This sensor assembly is cooled to 100 K. (Insert) BaTiO₃ diffraction spectrum taken at NSLS-2 with the 384-strip germanium detector.



(Above) 64-strip Ge detector at APS 6-BM located in far left and a human second metacarpal bone, from the Roman-era cemetery in the UK, in the near right of the photograph. (Right) EDD reconstruction.



R&D Accomplishments

- 384-strip detector with a 125 μ m pitch with Δ E < 500 eV at 60 keV at NSLS-2 XPD beamline
- 192-strip detector with 0.25 mm pitch with $\Delta E < 500 \text{ eV}$ at 60 keV at APS EDD beamline (6-BM-A)



NATIONAL LABORATORY



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APS Detector Group

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TES

• Ullom et al (NIST), Irwin et al (SLAC)

Germanium

• Siddons et al (BNL)

VIPIC

- Siddons et al (BNL)
- Deptuch et al (FNAL)

MM-PAD v2.0

• Gruner et al (Cornell)

